

► **Acquisition IP Modules**

These models can be configured for digital input mode by the setting of one or two jumpers. In this case, the board accepts input data Clock and input data Valid signals. This supports a continuous input Clock with data accepted only when the Data Valid line is true. The board can optionally generate a Data Suspend output signal indicating that these models are no longer capable of accepting data. The board accepts 32 bits from the front panel connector or from an on-board test signal generator.

Each IP module has an associated memory bank for buffering data in FIFO mode or for storing data in transient capture mode. Memory banks are supported with DMA engines for easily moving input data through the PCIe interface.

Generation IP Modules

These models can be configured for digital output mode by the setting of one or two jumpers. In this case, the board generates output data Clock and output Data Valid signals. This supports a continuous output Clock with data valid only when the Data Valid line is true. The board can optionally accept a Data Suspend input signal to halt data generation when the destination device is no longer capable of accepting data.

One or two linked-list controllers allow users to generate 32-bit digital words out through the front panel LVDS connector from tables stored in either on-board or off-board host memory. Parameters including length of table, delay from software trigger, table repetition, etc. can be programmed for entry. Up to 64 or 128 individual link entries can be chained together to create complex output patterns with minimum programming.

PCI Express Interface

These models include an industry-standard interface fully compliant with PCI Express Gen. 1 and 2 bus specifications. Supporting PCIe links up to x8, the interface includes multiple DMA controllers for efficient transfers to and from the board.

Memory Resources

The hardware architecture supports up to four or eight independent 512 MB memory banks of DDR3 SDRAM. The board is always configured with 1 GB of memory (Banks 1 and 2).

In addition to the factory-installed functions, custom user-installed IP within the FPGA can take advantage of the memories for many other purposes. For customers who need more memory to support their IP, Banks 3 and 4 can be optionally added for a total of 4 GB.

Specifications

Model 57610: Single LVDS Digital I/O

Model 58610: Dual LVDS Digital I/O

Front Panel Input/Output (1 or 2)

Data Lines: 35 LVDS differential pairs (32 pairs supported in factory-installed functions), 2.5 V compliant

Clock: One LVDS differential pair, 2.5 V compliant

Data Valid: One LVDS differential pair, 2.5 V compliant

Data Suspend: One LVDS differential pair, 2.5 V compliant

Field Programmable Gate Array (1 or 2)

Standard: Xilinx Virtex-6 XC6VLX130T

Optional: Xilinx Virtex-6 XC6VLX240T, or XC6VSX315T

Custom I/O

Option -104: Provides 20 LVDS pairs between the FPGA and the VPX P3 connector, Model 57610; P3 and P5, Model 58610

Option -105: Supports serial protocols by providing a 4X gigabit link between the FPGA and VPX P2, Model 57610; or one 4X link from each FPGA to P2 and an additional 4X link between the FPGAs, Model 58610

Memory Banks (1 or 2)

Standard: Two 512 MB DDR3 SDRAM memory banks (1 and 2), 400 MHz DDR

Option 165: Two 512 MB DDR3 SDRAM memory banks (3 and 4), 400 MHz DDR

PCI Express Interface

PCI Express Bus: Gen. 1 or 2: x4 or x8

Environmental: Level L1 & L2 air-cooled;

Level L3 ruggedized, conduction-cooled

Size: 3.937 in. x 6.717 in. (100 mm x 170.6 mm)

Ordering Information

Model Description

57610	Single LVDS Digital I/O with Virtex-6 FPGA - 6U VPX
58610	Dual LVDS Digital I/O with two Virtex-6 FPGAs - 6U VPX

Options:

-062	XC6VLX240T
-064	XC6VSX315T
-104	LVDS I/O between the FPGA and P3 connector, Model 57610; P3 and P5 connectors, Model 58610
-105	Gigabit link between the FPGA and P2 connector, Model 57610; gigabit links from each FPGA to P2 connector, Model 78610
-155*	Two 512 MB DDR3 SDRAM Memory Banks (Banks 1 and 2)
-165	Two 512 MB DDR3 SDRAM Memory Banks (Banks 3 and 4)

* This option is always required

Contact Pentek for availability of rugged and conduction-cooled versions